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Mullish

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

JACOBS, S.

Atty. Ref.: 604-616

Serial No. 09/834,014 ✓

Group: 2826

Filed: April 12, 2001 ✓

Examiner: Andujar, L.

For: MICROELECTRONIC PACKAGES INCLUDING THIN FILM DECAL AND
DIELECTRIC ADHESIVE LAYER HAVING CONDUCTIVE VIAS THEREIN, AND
METHODS OF FABRICATING THE SAME

* * * * *

April 4, 2003

Assistant Commissioner for Patents
Washington, DC 20231

Sir:

AMENDMENT

This is in response to the Official Action mailed October 4, 2002.

Reconsideration is respectfully requested. Claims 1-15 are in the case.

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